V8P22

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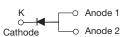
High Current Density Surface Mount TMBS[®] (Trench MOS Barrier Schottky) Rectifier

Ultra Low $V_F = 0.6 V$ at $I_F = 4 A$

eSMP[®] Series



SMPC (TO-277A)



ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS				
I _{F(AV)}	8 A			
V _{RRM}	200 V			
I _{FSM}	140 A			
V_F at $I_F = 8 A$	0.68 V			
T _J max.	175 °C			
Package	SMPC (TO-277A)			
Circuit configuration	Single			

FEATURES

- Very low profile typical height of 1.1 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- · Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 Automotive ordering code; base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

MECHANICAL DATA

Case: SMPC (TO-277A)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

MAXIMUM RATINGS ($T_A = 25 \text{ °C}$ unless otherwise noted)					
PARAMETER	SYMBOL	V8P22	UNIT		
Device marking code		V822			
Maximum repetitive peak reverse voltage	V _{RRM}	200	V		
Maximum average forward restified surrent (fig. 1)	I _{F(AV)} ⁽¹⁾	8	А		
Maximum average forward rectified current (fig. 1)	I _{F(AV)} ⁽²⁾	2.9			
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	140	А		
Operating junction temperature range	T _J ⁽³⁾	-40 to +175	°C		
Storage temperature range	T _{STG}	-55 to +175	°C		

Notes

⁽¹⁾ Mounted on 30 mm x 30 mm pad ares aluminum PCB

⁽²⁾ Free air, mounted on recommended pad area

 $^{(3)}$ The heat generated must be less than the thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{\theta JA}$

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RoHS

COMPLIANT

HALOGEN

V8P22



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ELECTRICAL CHARACTERISTICS ($T_A = 25$ °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 4 A	- T _A = 25 °C	V _F ⁽¹⁾	0.76	-	V
	I _F = 8 A			0.82	0.9	
	$I_F = 4 A$	T _A = 125 °C		0.60	-	
	I _F = 8 A			0.68	0.76	
Reverse current	V _B = 160 V	T _A = 25 °C	I _R ⁽²⁾	0.001	-	μA
	$v_{\rm R} = 100 v$	T _A = 125 °C		0.7	-	mA
	V _B = 200 V	T _A = 25 °C		-	0.1	μA
	$v_{\rm R} = 200 v$	T _A = 125 °C		1.5	7	mA
Typical junction capacitance	4.0 V, 1 MHz	4.0 V, 1 MHz		440	-	pF

Notes

⁽¹⁾ Pulse test: 300 µs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: Pulse width \leq 40 ms

THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise specified)				
PARAMETER	SYMBOL	V8P22	UNIT	
Typical thermal resistance	R _{0JA} ⁽¹⁾⁽²⁾	80	°C/W	
	R _{0JM} ⁽³⁾	4	0/10	

Notes

⁽¹⁾ The heat generated must be less than the thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{\theta JA}$

(2) Free air, mounted on recommended copper pad area, 2 oz., FR4 PCB, thermal resistance R_{0JA} - junction to ambient

 $^{(3)}$ Units mounted on recommended PCB, thermal resistance $R_{\theta JM}$ - junction to mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
V8P22-M3/H	0.10	Н	1500	7" diameter plastic tape and reel	
V8P22-M3/I	0.10	I	6500	13" diameter plastic tape and reel	
V8P22HM3/H ⁽¹⁾	0.10	Н	1500	7" diameter plastic tape and reel	
V8P22HM3/I ⁽¹⁾	0.10	I	6500	13" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES ($T_A = 25$ °C unless otherwise specified)

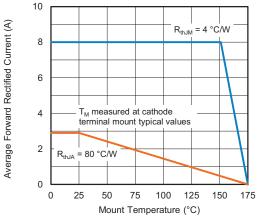


Fig. 1 - Maximum Forward Current Derating Curve

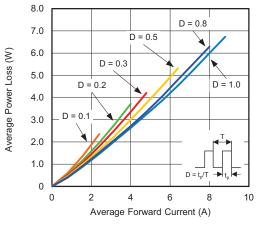
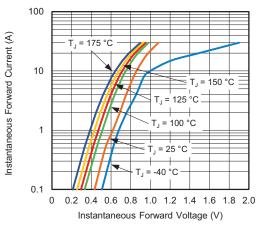
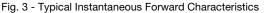


Fig. 2 - Forward Power Loss Characteristics





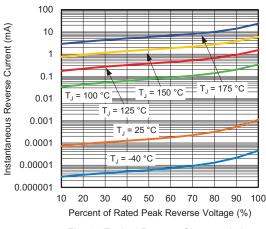


Fig. 4 - Typical Reverse Characteristics

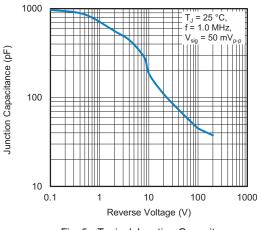
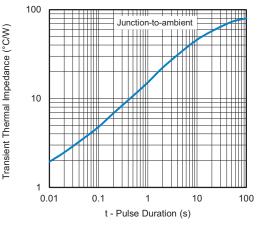
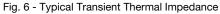


Fig. 5 - Typical Junction Capacitance



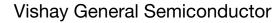


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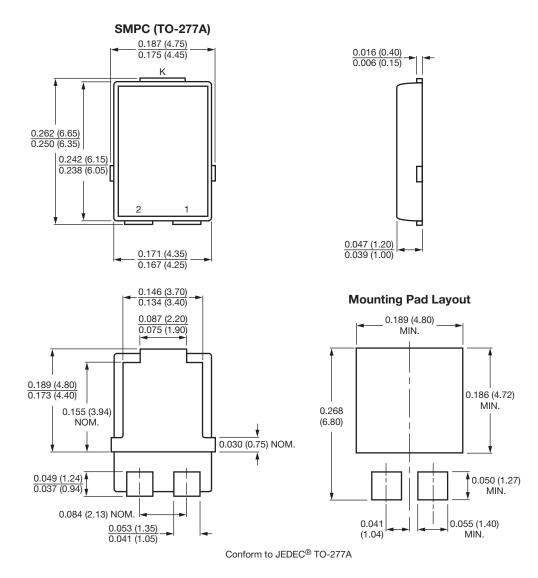
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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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